

Features

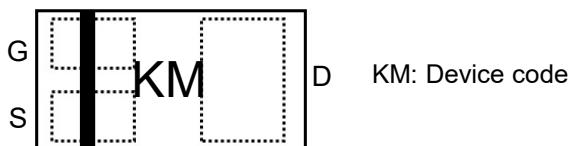
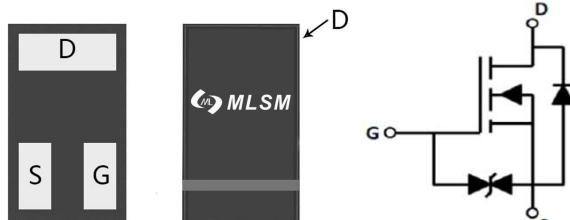
- Lead Free Product is Acquired
- Surface Mount Package
- N-Channel Switch with Low $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive
- ESD Protected Gate

Application

- Load Switch
- Portable Applications
- Power Management Functions

Product Summary

V_{DS}	$R_{DS(ON)} \text{ MAX}$	$I_D \text{ MAX}$
30V	500mΩ@4.5V	0.6A
	600mΩ@2.5V	



Marking and pin assignment



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)			
V_{DS}	Drain-Source Breakdown Voltage	30	V
V_{GS}	Gate-Source Voltage	±12	V
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-50 to 155	°C
I_S	Diode Continuous Forward Current	0.6	A
Mounted on Large Heat Sink			
I_{DM}	Pulse Drain Current Tested	2.4	A
I_D	Continuous Drain Current	0.6	A
P_D	Maximum Power Dissipation	275	mW
$R_{θJA}$	Thermal Resistance from Junction to Ambient	455	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLABA3144K	DFN1006-3L	KM	10,000	150,000	600,000	7" reel

Electrical Characteristics (TJ=25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	30	--	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V	-	--	1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±10V, V _{DS} =0V	-	--	±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.5	0.95	1.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =0.6A	-	290	500	mΩ
		V _{GS} =2.5V, I _D =0.3A	-	360	600	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =10V, V _{GS} =0V, f=1MHz	-	42	-	pF
C _{OSS}	Output Capacitance		-	9	-	pF
C _{RSS}	Reverse Transfer Capacitance		-	4.7	-	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =15V, I _D =0.6A, V _{GS} =10V	-	0.9	-	nC
Q _{gs}	Gate-Source Charge		-	0.4	-	nC
Q _{gd}	Gate-Drain Charge		-	0.2	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =10V, I _D =0.6A, V _{GS} =4.5V, R _G =10Ω	-	5	-	nS
t _r	Turn-on Rise Time		-	8.2	-	nS
t _{d(off)}	Turn-Off Delay Time		-	23	-	nS
t _f	Turn-off fall Time		-	41	-	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =0.6A	-	--	1.2	V

Typical Operating Characteristics

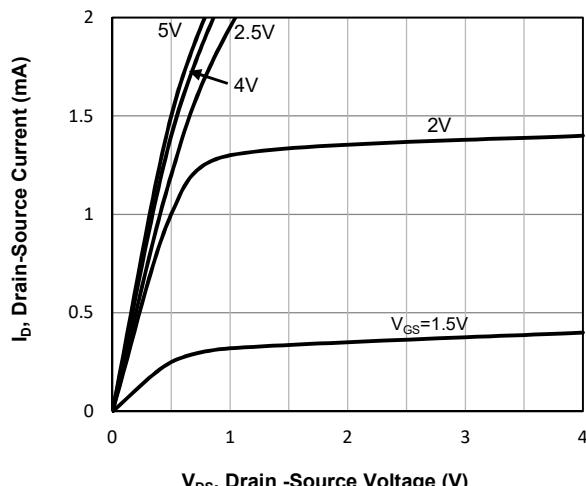


Fig1. Typical Output Characteristics

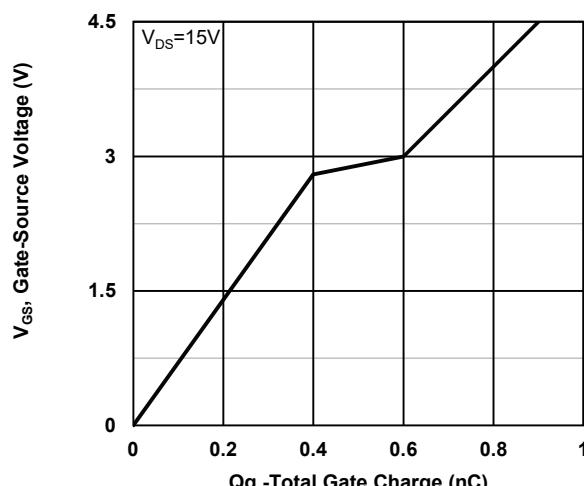


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

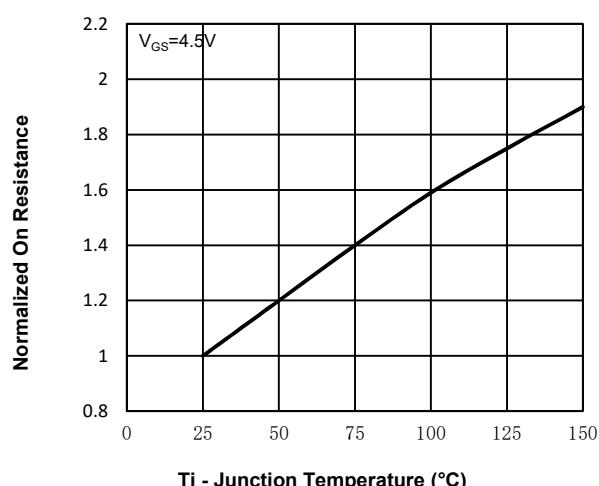


Fig3. Normalized On-Resistance Vs. Temperature

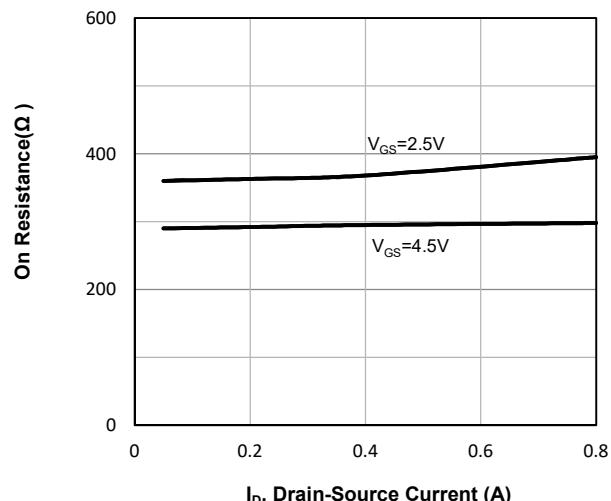


Fig4. On-Resistance Vs. Drain-Source Current

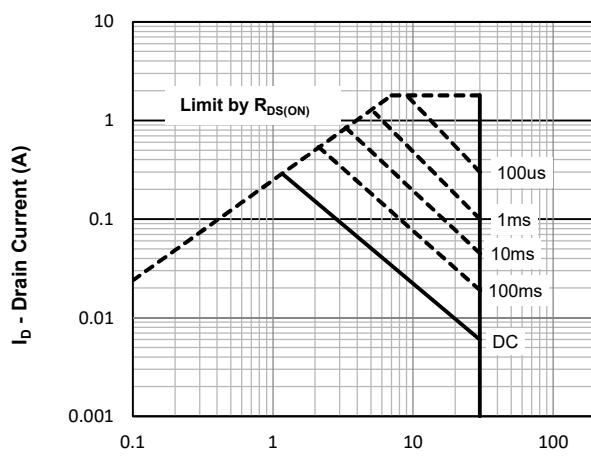


Fig5. Maximum Safe Operating Area

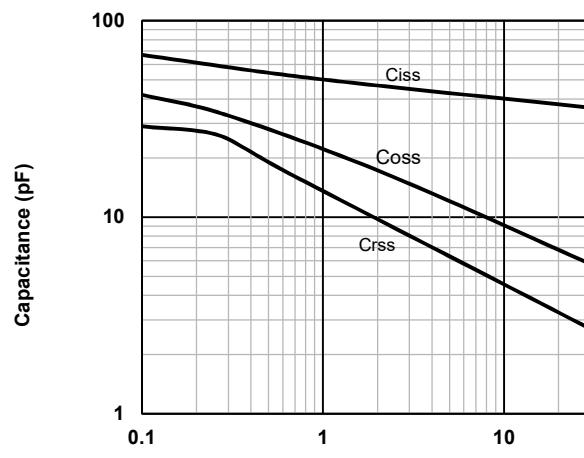
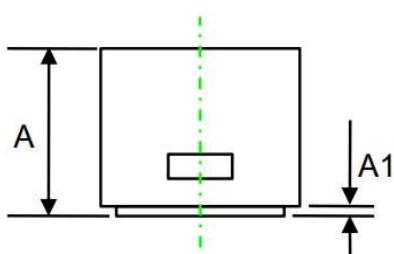
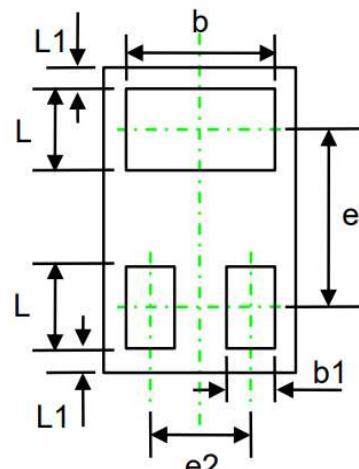
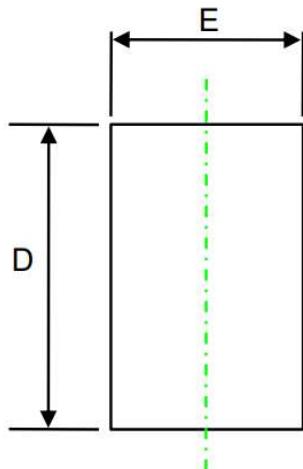


Fig6. Typical Capacitance Vs. Drain-Source Voltage

DFN1006-3L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.450	0.550	0.017	0.021
A1	0.000	0.030	0.000	0.001
D	0.950	1.050	0.037	0.041
E	0.550	0.650	0.021	0.025
b	0.470	0.550	0.018	0.021
e	0.65TYP		0.025TYP	
e2	0.35TYP		0.013TYP	
L1	0.05TYP		0.001TYP	
L	0.220	0.300	0.008	0.012
b1	0.110	0.190	0.004	0.007